







SLIN-06E2A Non-Isolated DC-DC Converter

The SLIN-06E2A power modules are non-isolated dc-dc converters that can deliver up to 6 A of output current. These modules operate over a wide input voltage range ($V_{\text{IN}} = 4.5 - 14 \text{ Vdc}$) and provide a precisely regulated output voltage from 0.59 to 5.5 Vdc, programmable via an external resistor.

Features include remote on/off, adjustable output voltage, over current and over temperature protection. A new feature, the Tunable $\mathsf{Loop}^\mathsf{TM}$, allows the user to optimize the dynamic response of the converter to match the load with reduced amount of output capacitance leading to savings on cost and PWB area.

Key Features & Benefits

- 4.5 14 VDC Input
- 0.59 5.5 VDC @ 6 A Output
- Wide Input Voltage Range
- Fixed Switching Frequency
- Power Good Signal
- Remote Sense
- Remote On/Off
- Ability to Sink and Source Current
- Cost Efficient Open Frame Design
- Over Temperature Protection
- Output Over Current Protection
- Tunable Loop™ (a Registered Trademark of Lineage Power Systems) to Optimize Dynamic Output Voltage Response
- Certificated to UL/CSA 62368-1
- Class II, Category 2, Non-Isolated DC-DC Converter (refer to IPC-9592B)

Applications

- Distributed Power Architectures
- Intermediate Bus Voltage Applications
- Telecommunications Equipment
- Servers and Storage Applications
- Networking Equipment
- Industrial Equipment



1. MODEL SELECTION

MODEL NUMBER	OUTPUT VOLTAGE	INPUT VOLTAGE	MAX. OUTPUT CURRENT	MAX. OUTPUT POWER	TYPICAL EFFICIENCY
SLIN-06E2A0G					
SLIN-06E2A0R	0.50 5.5.400	4.5 - 14 VDC	0.4	33 W	040/
SLIN-06E2ALG	0.59 - 5.5 VDC		6 A		91%
SLIN-06E2ALR					

PART NUMBER EXPLANATION

s	LIN	- 06	E	2A	х	у
Mounting Type	Series Code	Output Current	Input Voltage Range	Sequencing or not	Active Logic	Package Type
Surface Mount	SLIN Series	6 A	4.5 - 14 V	without Sequencing	L – Active Low 0 – Active High	G – Tray Package R – Tape and Reel Package

2. ABSOLUTE MAXIMUM RATINGS

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNITS
Continuous non-operating Input Voltage	ge	-0.3	-	15	V
Ambient Temperature		-40	-	85	°C
Storage Temperature		-55	-	125	°C
Altitude		-	-	2000	m

NOTE: Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only, functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect the device reliability.

3. INPUT SPECIFICATIONS

All specifications are typical at 25°C unless otherwise stated.

PARAMETER		DESCRIPTION	MIN	TYP	MAX	UNIT
Operating Input Voltage			4.5	-	14	V
Input Current (full load)		Test at 9 V input voltage	-	-	6.5	Α
Input Current (no load)	Vo = 0.6 V	V _{IN} = 4.5 to 14 V	-	16	-	mA
	Vo = 3.3 V	$V_{IN} = 4.5 \text{ to } 14 \text{ V}$	-	55	-	mA
Remote Off Input Current		V _{IN} = 12.0 Vdc, module disabled	-	1.2	-	mA
Input Reflected Ripple Current (pk-pk)		5 Hz to 20 MHz, 1 uH source impedance; VIN = 0 to 14 V, Io = Iomax; See Test Configurations	-	86	-	mA
I ² t Inrush Current Transient			-	-	1	A^2s
Input Ripple Rejection (120	Hz)		-	50	-	dB
Turn-on Voltage Threshold			-	-	4.3	V
Turn-off Voltage Threshold			3.4	-	-	V
Hysteresis			0.4	-	-	V

CAUTION: This converter is not internally fused. An input line fuse must be used in application.

This power module can be used in a wide variety of applications, ranging from simple standalone operation to an integrated part of sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a fast-acting fuse with a maximum rating of 6A. Based on the information provided in this data sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's data sheet for further information.

Note: Unless otherwise indicated, specifications apply over entire operating input voltage range, resistive load, and temperature conditions.



4. OUTPUT SPECIFICATIONS

All specifications are typical at nominal input, full load at 25°C unless otherwise stated.

Output Voltage Set Point with 0.5% tolerance for external resistor used to set output voltage range, resistive load, and temperature conditions until end of life -1.5 - 1.5 %Vo, set Adjustment Range 0.59 - 5.5 V Remote Sense Range - - 0.59 - 5.5 V Load Regulation Vo ≥ 2.5 V Vo < 2.5 V Io = Io, min to Io, max - - 10 mV Line Regulation Vo ≥ 2.5 V Vo < 2.5 V VIN = VIN, min 10 VINL, max - - 0.4 %Vo, set mV Line Regulation Vo ≥ 2.5 V Vo < 2.5 V VIN = VINL, min 10 VINL, max - - 0.4 %Vo, set mV Line Regulation Vo ≥ 2.5 V Vo < 2.5 V VIN = VINL, min 10 VINL, max - - 0.4 %Vo, set mV Line Regulation Vo ≥ 2.5 V VIN = VINL, min 10 VINL, max - - 0.4 %Vo, set mV Temperature Regulation Vo ≥ 2.5 V VIN = VINL, min 10 VINL, max - - 0.4 %Vo, set mV Ripple and Noise (pk-pk) 5 Hz to 20 MHz BW, VIN = VINL, mon and lo Io, min to Io, max Co = 0.1 µF // 10 µF<	PARAMETER		DESCRIPTION	MIN	TYP	MAX	UNIT
Output Voltage resistive load, and temperature conditions until end of life -2.5 - 2.5 %Vo, set Adjustment Range 0.59 - 5.5 V Remote Sense Range - - - 0.5 V Load Regulation Vo ≥ 2.5 V Vo < 2.5 V	Output Voltage Set Point		used to set output voltage	-1.5	-	1.5	%Vo,set
Remote Sense Range $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Output Voltage		resistive load, and temperature conditions	-2.5	-	2.5	%Vo,set
	Adjustment Range			0.59	-	5.5	V
Line Regulation $V_0 < 2.5 \text{ V}$ $V_0 < 2.5 \text{ V}$ $V_{IN} = V_{IN, min} \text{ to } V_{IN, max}$	Remote Sense Range			-	-	0.5	V
Temperature Regulation 0.4 %Vo,set Ripple and Noise (pk-pk) 5 Hz to 20 MHz BW, VIN = VIN, nom and lo = lo, min to lo, max Co = 0.1 μ F // 10 μ F ceramic capacitors) - 20 38 mV Output Current Range In either sink or source mode 0 - 6 A Output DC Current Limit Hiccup Mode 200 %lo, max Output Short-Circuit Current Vo ≤ 250 mV, Hiccup Mode - 170 - mA Output Capacitance ESR ≥ 1 m Ω Without the Tunable Loop TM 0 - 47 μ F ESR ≥ 0.15 m Ω With the Tunable Loop TM 0 - 1000 μ F Case 1: On/Off input is enabled and then input power is applied (delay from instant at which $V_{IN} = V_{IN}$, min until $V_{O} = 10\%$ of V_{O} , set V_{O} is enabled (delay from instant at which V_{O}) Firm for V_{O} to rise from 10% of V_{O} , set V_{O} in to Voltage Rise Time Output Voltage Overshoot Output or maximum external 3 %Vo, set V_{O}	Load Regulation	- ·	Io = Io, min to Io, max	- -	- -		
Ripple and Noise (pk-pk) $ \begin{array}{c} 5 \text{ Hz to } 20 \text{ MHz BW, VIN = VIN, nom and} \\ I_0 = I_{0, min} \text{ to } I_{0, max} \text{ Co} = 0.1 \mu\text{F} / 10 \mu\text{F} \\ \text{ceramic capacitors} \end{array}) \\ \text{Output Current Range} \\ \text{Output Current Range} \\ \text{In either sink or source mode} \\ \text{Output DC Current Limit} \\ \text{Hiccup Mode} \\ \text{Output Short-Circuit Current} \\ \text{Output Short-Circuit Current} \\ \text{Output Short-Circuit Current} \\ \text{Output Capacitance} \\ \text{ESR} \geq 1 \text{ m}\Omega \\ \text{ESR} \geq 0.15 \text{ m}\Omega \\ \text{ESR} \geq 0.15 \text{ m}\Omega \\ \text{ESR} \geq 10 \text{ m}\Omega \\ \end{array} $ $\begin{array}{c} \text{With out the Tunable Loop}^{\text{TM}} \\ \text{With the Tunable Loop}^{\text{TM}} \\ \text{Output Short-Circuit Current} \\ \end{array} \begin{array}{c} \text{Output Gapacitance} \\ \text{ESR} \geq 0.15 \text{ m}\Omega \\ \text{ESR} \geq 0.15 \text{ m}\Omega \\ \text{ESR} \geq 0.15 \text{ m}\Omega \\ \end{array} \begin{array}{c} \text{With the Tunable Loop}^{\text{TM}} \\ \text{With the Tunable Loop}^{\text{TM}} \\ \text{Output Short-Circuit} \\ \end{array} \begin{array}{c} \text{Output Short-Circuit Current}} \\ \text{Output Woltage Time} \\ \end{array} \begin{array}{c} \text{Case 1: On/Off input is enabled and then} \\ \text{Input power is applied (delay from instant at which Von/Off is enabled until Vo = 10% of Vo, set)} \\ \text{Turn-On Delay Time} \\ \text{Output Voltage Rise Time} \\ \end{array} \begin{array}{c} \text{Case 2: Input power is applied for at least} \\ \text{one second and then the On/Off input is} \\ \text{enabled (delay from instant at which Von/Off} \\ \text{is enabled until Vo} = 10\% \text{ of Vo, set to} \\ \text{90\% of Vo, set} \\ \text{Vin = Vin, min to Vin, max, lo = lo, min to} \\ \text{Io, max, With or without maximum external} \\ \text{-} \\ \text{-} \\ \text{-} \\ \text{3} \\ \text{3} \\ \text{6Vo, set} \\ \end{array}$	Line Regulation		$V_{IN} = V_{IN,\;min}\;to\;V_{IN,\;max}$	- -	- -		,
Ripple and Noise (RMS)	Temperature Regulation			-	-	0.4	%Vo,set
Ripple and Noise (RMS) ceramic capacitors) - 20 38 mV Output Current Range In either sink or source mode 0 - 6 A Output DC Current Limit Hiccup Mode 200 %lo,max Output Short-Circuit Current Vo ≤ 250 mV, Hiccup Mode - 170 - mA Output Capacitance ESR ≥ 1 m Without the Tunable Loop TM 0 - 47 µF ESR ≥ 0.15 m With the Tunable Loop TM 0 - 1000 µF ESR ≥ 10 m With the Tunable Loop TM 0 - 3000 µF Case 1: On/Off input is enabled and then input power is applied (delay from instant at which V _{IN} = V _{IN} , min Until Vo = 10% of Vo, set) Turn-On Delay Time Case 2: Input power is applied for at least one second and then Con/Off input is enabled until Vo = 10% of Vo, set) Output Voltage Rise Time Time for Vo to rise from 10% of Vo, set to 90% of Vo, set to 90% of Vo, set Vin = Vin, min to Vin, max, lo = lo, min to Voltage Overshoot Io, max, With or without maximum external 3 %Vo, set	Ripple and Noise (pk-pk)			-	50	100	mV
Output DC Current Limit Hiccup Mode	Ripple and Noise (RMS)			-	20	38	mV
Output Short-Circuit Current $Vo \le 250 \text{ mV}$, Hiccup Mode - 170 - mA Output Capacitance $ESR \ge 1 \text{ m}\Omega$ Without the Tunable $Loop^{TM}$ 0 - 47 μF $ESR \ge 0.15 \text{ m}\Omega$ With the Tunable $Loop^{TM}$ 0 - 1000 μF $ESR \ge 10 \text{ m}\Omega$ With the Tunable $Loop^{TM}$ 0 - 3000 μF $ESR \ge 10 \text{ m}\Omega$ With the Tunable $Loop^{TM}$ 0 - 3000 μF Case 1: On/Off input is enabled and then input power is applied (delay from instant at which $V_{IN} = V_{IN}$, min until $Vo = 10\%$ of Vo , set) Turn-On Delay Time Case 2: Input power is applied for at least one second and then the On/Off input is enabled (delay from instant at which Von/Off is enabled (delay from instant at which Von/Off is enabled until $Vo = 10\%$ of Vo , set) Output Voltage Rise Time Time for Vo to rise from 10% of Vo, set to 90% of Vo, set Vin = Vin, min to Vin, max, $Io = Io$, min to Output Voltage Overshoot Io , max, With or without maximum external 3 %Vo,set	Output Current Range		In either sink or source mode	0	-	6	А
Output Capacitance ESR ≥ 1 mΩ ESR ≥ 0.15 mΩ ESR ≥ 0.15 mΩ Without the Tunable Loop TM 0 - 1000 μF 0 - 1000 μF Turn-On Delay Time Case 1: On/Off input is enabled and then input power is applied (delay from instant at which $V_{IN} = V_{IN, min}$ until $V_{IN} = V_{IN, m$	Output DC Current Limit		Hiccup Mode	-	-	200	%lo,max
$ ESR \ge 0.15 \ m\Omega \\ ESR \ge 10 \ m\Omega \\ With the Tunable Loop^{TM} \\ With the Tunable Loop^{TM} \\ Case 1: On/Off input is enabled and then input power is applied (delay from instant at which V_{IN} = V_{IN, min} until V$	Output Short-Circuit Cur	rent	Vo ≤ 250 mV, Hiccup Mode	-	170	-	mA
input power is applied (delay from instant at which $V_{IN} = V_{IN, min}$ until $V_0 = 10\%$ of V_0 , set) Turn-On Delay Time Case 2: Input power is applied for at least one second and then the On/Off input is enabled (delay from instant at which V_0) Enabled (delay from instant at which V_0) Output Voltage Rise Time Time for V_0 to rise from 10% of V_0 , set to 90% of V_0 , set Vin = Vin, min to Vin, max, V_0 = Io, min to Output Voltage Overshoot input power is applied (delay from instant at which V_0 , set) Time for V_0 rise from 10% of V_0 , set to 90% of V_0 , set V_0 and V_0 rise from 10% of V_0 , set V_0 and V_0 are V_0 and V_0 are V_0 are V_0 are V_0 are V_0 and V_0 are V_0 are V_0 are V_0 are V_0 and V_0 are V_0 are V_0 are V_0 and V_0 are V_0 and V_0 are V_0 are V_0 and V_0 are	Output Capacitance	ESR ≥ 0.15 mΩ	With the Tunable Loop TM	0		1000	μF
one second and then the On/Off input is enabled (delay from instant at which Von/Off is enabled until Vo =10% of Vo, set) Output Voltage Rise Time Time for Vo to rise from 10% of Vo, set to 90% of Vo, set Vin = Vin, min to Vin, max, lo = lo, min to Output Voltage Overshoot	Turn-On Delay Time		input power is applied (delay from instant at which $V_{IN} = V_{IN,min}$ until $Vo = 10\%$ of $Vo,set)$	-	2	-	ms
Output Voltage Rise Time 90% of Vo, set Vin = Vin, min to Vin, max, Io = Io, min to Output Voltage Overshoot Io, max, With or without maximum external - 3 %Vo,set	·		one second and then the On/Off input is enabled (delay from instant at which Von/Off	-	2	-	ms
Vin = Vin, min to Vin, max, Io = Io, min to Output Voltage Overshoot Io, max, With or without maximum external 3 %Vo,set	Output Voltage Rise Time	Э		-	4	-	ms
	Output Voltage Overshoo	ot	Vin = Vin, min to Vin, max, Io = Io, min to Io, max, With or without maximum external	-	-	3	%Vo,set

Notes:

- 1. Some output voltages may not be possible depending on the input voltage.
- 2. External capacitors may require using the new Tunable LoopTM feature to ensure that the module is stable as well as getting the best transient response (See the Tunable LoopTM section for details).
- Unless otherwise indicated, specifications apply over entire operating input voltage range, resistive load, and temperature conditions.



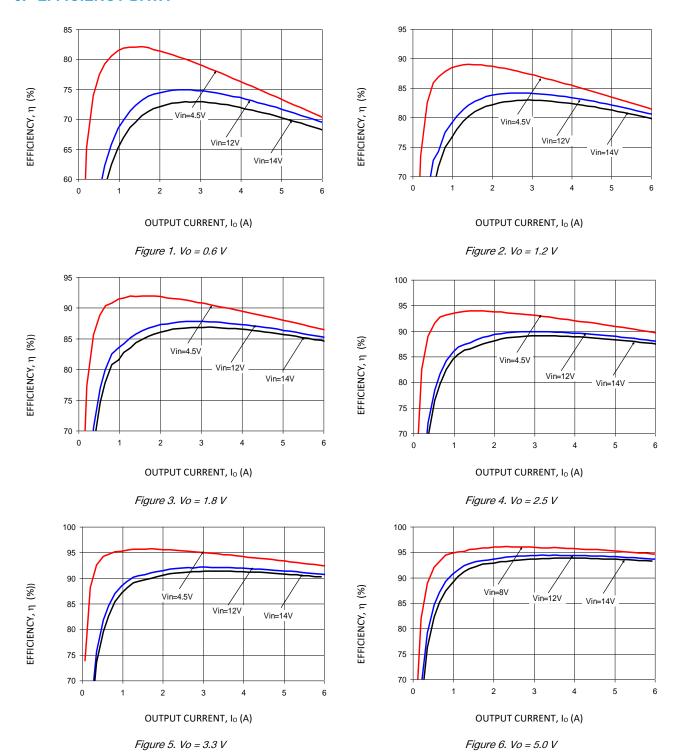
5. GENERAL SPECIFICATIONS

PARAMETER		DESCRIPTION	MIN	TYP	MAX	UNIT
	Vo = 0.6 V			69.3		
	Vo = 1.2 V			80.7		
Efficiency	Vo = 1.8 V	Vin = 12 VDC, Ta = 25°C		85.3		%
	Vo = 2.5 V	Io = Io, max , Vo = Vo,set	-	88.1	-	%0
	Vo = 3.3 V			90.8		
	Vo = 5.0 V			93.6		
Switching Freque	ency		-	600	-	kHz
Over Temperatur	re Protection		-	140	-	°C
PGOOD (Power	Good)					
Output Voltage L	imit for PGOOD	Signal Interface Open Drain, Vsupply $\leq 5 \text{ Vdc}$	90	-	110	%Vo,set
Pulldown resista	nce of PGOOD pin		-	7	50	Ω
Weight			-	1.95	-	g
Dimoneione (L. v.	Dimensions (L × W × H)		0.48	x 0.48 x	0.285	inch
Difficitions (L x	VV ^ 11)		12.19	x 12.19	x 7.25	mm

Note: Unless otherwise indicated, specifications apply over entire operating input voltage range, resistive load, and temperature conditions.

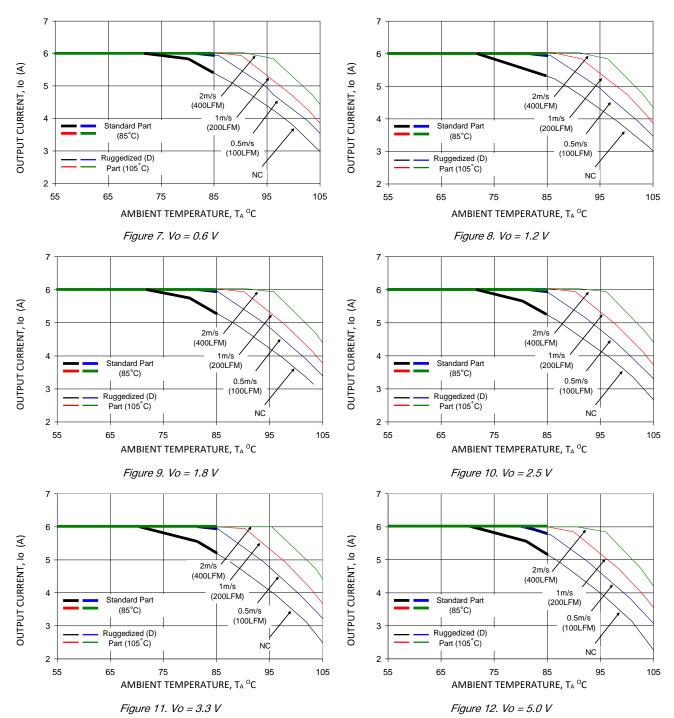


6. EFFICIENCY DATA





7. THERMAL DERATING CURVE





OUTPUT VOLTAGE VO (V) (10Mv/div)

OUTPUT VOLTAGE VO (V) (10Mv/div)

OUTPUT VOLTAGE VO (V) (20Mv/div)

8. RIPPLE AND NOISE WAVEFORMS

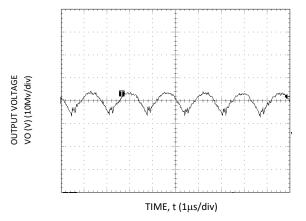


Figure 13. Vo = 0.6 V, Io = Io,max

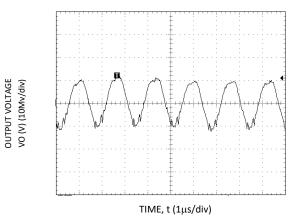
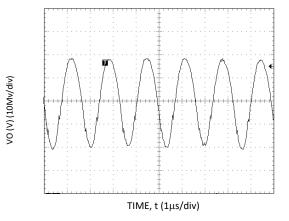


Figure 15. Vo = 1.8 V, Io = Io,max



OUTPUT VOLTAGE

Figure 17. Vo = 3.3 V, Io = Io,max

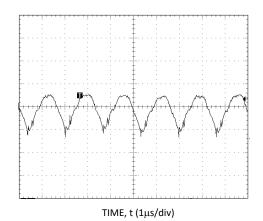


Figure 14. Vo = 1.2 V, Io = Io,max

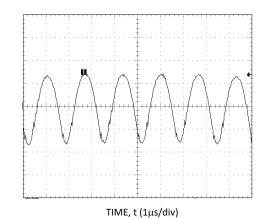


Figure 16. Vo = 2.5 V, Io = Io,max

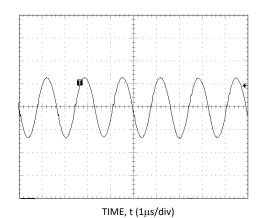


Figure 18. Vo = 5.0 V, Io = Io, max



Asia-Pacific +86 755 298 85888 Europe, Middle East +353 61 49 8941 North America +1 866 513 2839 OUTPUT VOLTAGE VO (V) (200Mv/div)

OUTPUT CURRENT,

IO (A) (2Adiv)

OUTPUT VOLTAGE VO (V) (200Mv/div)

OUTPUT CURRENT, IO (A) (2Adiv)

9. TRANSIENT RESPONSE WAVEFORMS

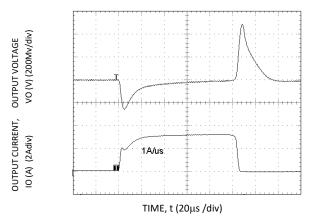


Figure 19. Transient Response to Dynamic Load Change from 0% 50% to 0%. Vo = 0.6 V

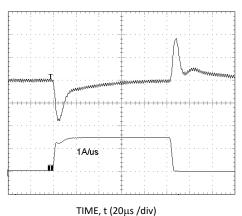


Figure 21. Transient Response to Dynamic Load Change from 0% 50% to 0%. Vo = 1.8 V

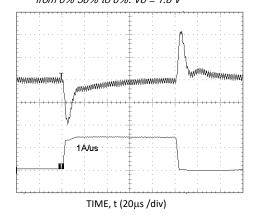
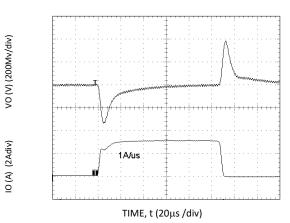


Figure 23. Transient Response to Dynamic Load Change from 0% 50% to 0%. Vo = 3.3 V



OUTPUT VOLTAGE

OUTPUT CURRENT,

VO (V) (200Mv/div)

OUTPUT VOLTAGE

OUTPUT CURRENT,

IO (A) (2Adiv)

VO (V) (200Mv/div)

OUTPUT VOLTAGE

OUTPUT CURRENT,

IO (A) (2Adiv)

Figure 20. Transient Response to Dynamic Load Change from 0% 50% to 0%. Vo = 1.2 V

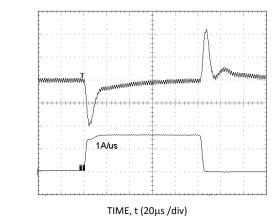


Figure 22. Transient Response to Dynamic Load Change from 0% 50% to 0%. Vo = 2.5 V

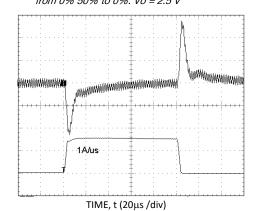


Figure 24. Transient Response to Dynamic Load Change from 0% 50% to 0%. Vo = 5.0 V



OUTPUT VOLTAGE Vo (V) (500Mv/div)

Von/OFF (V) (5V/div)

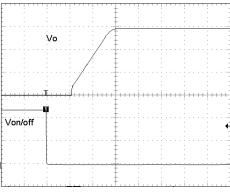
10. STARTUP TIME

ON/OFF VOLTAGE OUTPUT VOLTAGE Von/OFF (V) (5V/div) Vo (V) (200Mv/div)

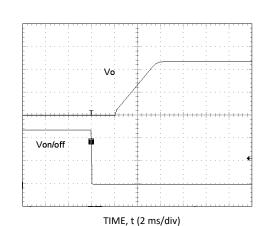
VO (V) (1V/div)

/ON/OFF (V) (5V/div)

ON/OFF VOLTAGE OUTPUT VOLTAGE



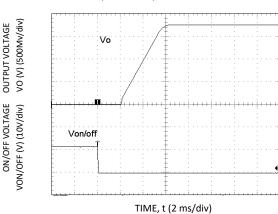


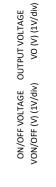


TIME, t (2 ms/div)

Figure 25. Start-up Using On/Off Voltage
(lo = lo,max), Vo = 0.6 V

Figure 26. Start-up Using On/Off Voltage (lo = lo,max), Vo = 1.2 V





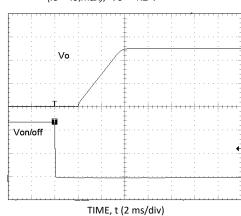
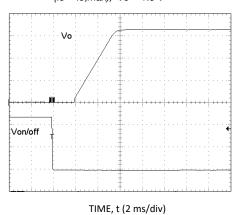


Figure 27. Start-up Using On/Off Voltage (lo = lo,max), Vo = 1.8 V

Figure 28. Start-up Using On/Off Voltage (Io = Io,max), Vo = 2.5 V



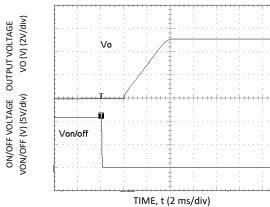


Figure 29. Start-up Using On/Off Voltage (Io = Io,max), Vo = 3.3 V

Figure 30. Start-up Using On/Off Voltage (Io = Io,max), Vo = 5.0 V



OUTPUT VOLTAGE

V₀ (V) (1V/div)

Vin (V) (5V/div) ON/OFF VOLTAGE

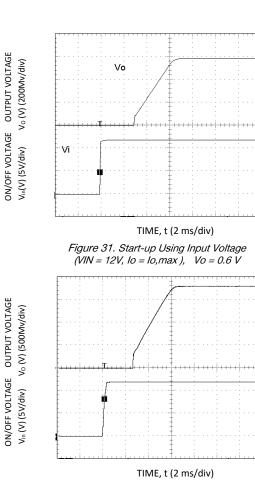


Figure 33. Start-up Using Input Voltage (VIN = 12V, Io = Io, max), Vo = 1.8 V

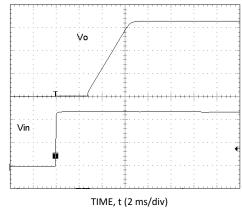
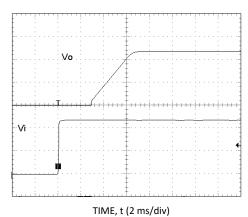


Figure 35. Start-up Using Input Voltage (VIN = 12V, Io = Io, max), Vo = 3.3 V



OUTPUT VOLTAGE

ON/OFF VOLTAGE

OUTPUT VOLTAGE

INPUT VOLTAGE $V_{in}(V)$ (5V/div)

OUTPUT VOLTAGE V₀ (V) (2V/div)

ON/OFF VOLTAGE Vin (V) (5V/div)

V₀ (V) (1V/div)

V_{in} (V) (5V/div)

V₀ (V) (500Mv/div)

Figure 32. Start-up Using Input Voltage (VIN = 12V, Io = Io, max), Vo = 1.2 V

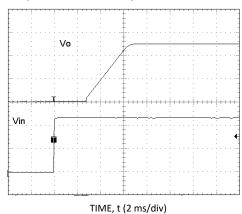


Figure 34. Start-up Using Input Voltage (VIN = 12V, Io = Io, max), Vo = 2.5 V

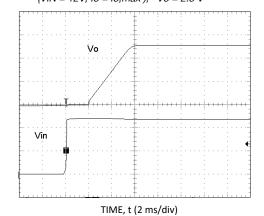
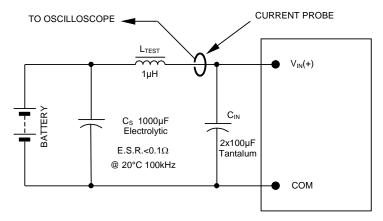


Figure 36. Start-up Using Input Voltage (VIN = 12V, Io = Io, max), Vo = 5.0 V



11. TEST CONFIGURATIONS

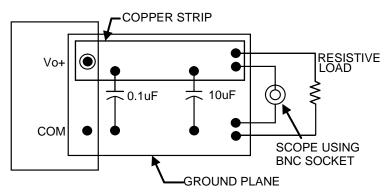
Input Reflected Ripple Current Test Setup.



NOTE: Measure input reflected ripple current with a simulated source inductance (L_{TEST}) of 1µH. Capacitor C_S offsets possible battery impedance. Measure current as shown above

Figure 37.

Output Ripple and Noise Test Setup

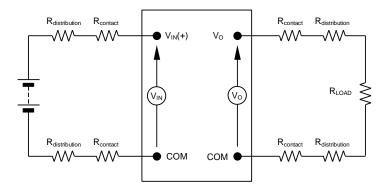


NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

Figure 38.



Output Voltage and Efficiency Test Setup



NOTE: All voltage measurements to be taken at the module terminals, as shown above. If sockets are used then Kelvin connections are required at the module terminals to avoid measurement errors due to socket contact resistance.

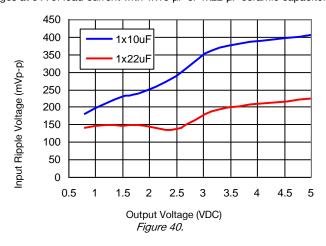
Efficiency
$$\eta = \frac{V_0. I_0}{V_{IN}. I_{IN}}$$
 x 100 %

Figure 39.

12. INPUT FILTERING

The SLIN-06E2A module should be connected to a low ac-impedance source. A highly inductive source can affect the stability of the module. An input capacitance must be placed directly adjacent to the input pin of the module, to minimize input ripple voltage and ensure module stability.

To minimize input voltage ripple, ceramic capacitors are recommended at the input of the module. Below figure shows the input ripple voltage for various output voltages at 6 A of load current with $1x10 \mu F$ or $1x22 \mu F$ ceramic capacitors and an input of 12 V.



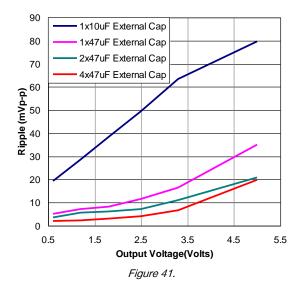
Note: Input ripple voltage for various output voltages with $1x10~\mu F$ or $1x22~\mu F$ ceramic capacitors at the input (6 A load). Input voltage is 12~V.



13. OUTPUT FILTERING

The SLIN-06E2A modules are designed for low output ripple voltage and will meet the maximum output ripple specification with 0.1 μ F ceramic and 10 μ F ceramic capacitors at the output of the module. However, additional output filtering may be required by the system designer for a number of reasons. First, there may be a need to further reduce the output ripple and noise of the module. Second, the dynamic response characteristics may need to be customized to a particular load step change.

To reduce the output ripple and improve the dynamic response to a step load change, additional capacitance at the output can be used. Low ESR polymer and ceramic capacitors are recommended to improve the dynamic response of the module. The figure provides output ripple information for different external capacitance values at various Vo and for a load current of 6 A. For stable operation of the module, limit the capacitance to less than the maximum output capacitance as specified in the electrical specification table. Optimal performance of the module can be achieved by using the Tunable LoopTM feature described later in this data sheet.



Note: Output ripple voltage for various output voltages with external $1x10~\mu F$, $1x47~\mu F$, $2x47~\mu F$ or $4x47~\mu F$ ceramic capacitors at the output (6 A load). Input voltage is 12~V.

14. SAFETY CONSIDERATIONS

For safety agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards, i.e., UL/CSA 62368-1.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a fast-acting fuse with a maximum rating of 6 A in the positive input lead.



15. REMOTE ON/OFF

PARAMETER		DESCRIPTION	MIN	TYP	MAX	UNIT
Signal Low (Unit On)	Active Low	The remote on/off pin open, Unit on.	-0.3	-	0.6	V
Signal High (Unit Off)	Active Low		3.5	-	Vin,max	V
Signal Low (Unit Off)	A attion I limb	The remote on/off pin open, Unit on.	-0.3	-	0.8	V
Signal High (Unit On)	Active High		3.5	-	Vin,max	V

The SLIN-06E2A power modules feature an On/Off pin for remote On/Off operation. Two On/Off logic options are available. In the Positive Logic On/Off option, the module turns ON during a logic High on the On/Off pin and turns OFF during a logic Low. With the Negative Logic On/Off option, the module turns OFF during logic High and ON during logic Low. The On/Off signal is always referenced to ground. For either On/Off logic option, leaving the On/Off pin disconnected will turn the module ON when input voltage is present.

For positive logic modules, the circuit configuration for using the On/Off pin is shown in below figure. When the external transistor Q1 is in the OFF state, the internal PWM Enable signal is pulled high through an internal 1.5 M Ω resistor and the external pullup resistor and the module is ON. When transistor Q1 is turned ON, the On/Off pin is pulled low and the module is OFF. A suggested value for Rpullup is 20 k Ω .

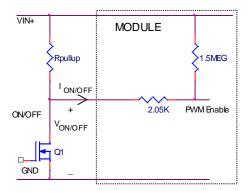


Figure 42. Circuit configuration for using positive On/Off logic

For negative logic On/Off modules, the circuit configuration is shown in below. The On/Off pin should be pulled high with an external pull-up resistor (suggested value for the 4.5 V to 14 V input range is 20 k Ω). When transistor Q2 is in the OFF state, the On/Off pin is pulled high, transistor Q1 is turned ON and the module is OFF. To turn the module ON, Q2 is turned ON pulling the On/Off pin low, turning transistor Q1 OFF resulting in the PWM Enable pin going high.

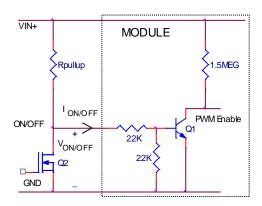


Figure 43. Circuit configuration for using negative On/Off logic



16. OVER CURRENT PROTECTION

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting continuously. At the point of current-limit inception, the unit enters hiccup mode. The unit operates normally once the output current is brought back into its specified range.

17. OVER TEMPERATURE PROTECTION

To provide protection in a fault condition, the unit is equipped with a thermal shutdown circuit. The unit will shut down if the over temperature threshold of 140°C is exceeded at the thermal reference point Tref. The thermal shutdown is not intended as a guarantee that the unit will survive temperatures beyond its rating. Once the unit goes into thermal shutdown it will then wait to cool before attempting to restart.

18. INPUT UNDER-VOLTAGE LOCKOUT

At input voltages below the input under voltage lockout limit, the module operation is disabled. The module will begin to operate at an input voltage above the under-voltage lockout turn-on threshold.

19. OUTPUT VOLTAGE PROGRAMMING

The output voltage of the SLIN-06E2A modules can be programmed to any voltage from 0.59 VDC to 5.5 VDC by connecting a resistor between the Trim and GND pins of the module. Certain restrictions apply on the output voltage set point depending on the input voltage. These are shown below. The Limit curve shows that for output voltages of 0.9 V and lower, the input voltage must be lower than the maximum of 14 V. The Lower Limit curve shows that for output voltages of 3.8 V and higher, the input voltage needs to be larger than the minimum of 4.5 V.

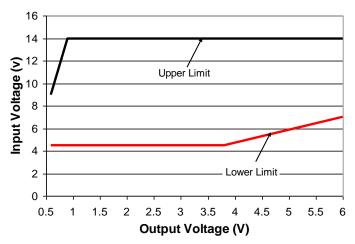


Figure 44.

Output Voltage vs. Input Voltage Set Point Area plot showing limits where the output voltage can be set for different input voltages.



20. OUTPUT TRIM EQUATIONS

Without an external resistor between Trim and GND pins, the output of the module will be 0.59 VDC. To calculate the value of the trim resistor, Rtrim for a desired output voltage, use the following equation:

$$Rtrim = \left[\frac{5.91}{(Vo - 0.591)}\right] K\Omega$$

Rtrim is the external resistor in $K\Omega$ Vo is the desired output voltage.

Table 1 provides Rtrim values required for some common output voltages.

VO, set (V)	Rtrim (kΩ)
0.6	656.7
1.0	14.45
1.2	9.704
1.5	6.502
1.8	4.888
2.5	3.096
3.3	2.182
5.0	1.340

Table 1.

By using a $\pm 0.5\%$ tolerance trim resistor with a TC of ± 100 ppm, a set point tolerance of $\pm 1.5\%$ can be achieved as specified in the electrical specification.

21. REMOTE SENSE

The SLIN-06E2A power modules have a Remote Sense feature to minimize the effects of distribution losses by regulating the voltage at the SENSE pin. The voltage between the SENSE pin and VOUT pin must not exceed 0.5 V. Note that the output voltage of the module cannot exceed the specified maximum value. This includes the voltage drop between the SENSE and Vout pins. When the Remote Sense feature is not being used, connect the SENSE pin to the VOUT pin.

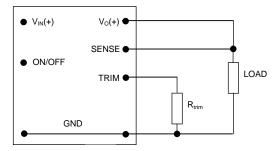


Figure 45. Circuit configuration for programming output voltage using an external resistor



22. VOLTAGE MARGINING

Output voltage margining can be implemented in the SLIN-06E2A modules by connecting a resistor, R_{margin-up}, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, R_{margin-down}, from the Trim pin to output pin for margining-down.

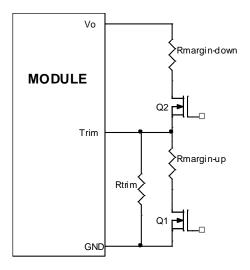


Figure 46.
Circuit Configuration for margining Output voltage

23. MONOTONIC START-UP AND SHUTDOWN

The SLIN-06E2A modules have monotonic start-up and shutdown behavior for any combination of rated input voltage, output current and operating temperature range.

24. STARTUP INTO PRE-BIASED OUTPUT

The SLIN-06E2A modules can start into a pre-biased output as long as the pre-bias voltage is 0.5 V less than the set output voltage. Note that pre-bias operation is not supported when output voltage sequencing is used.

25. POWER GOOD

The SLIN-06E2A provide a Power Good (PGOOD) signal that is implemented with an open-drain output to indicate that the output voltage is within the regulation limits of the power module. The PGOOD signal will be de-asserted to a low state if any condition such as over temperature, over current or loss of regulation occurs that would result in the output voltage going $\pm 10\%$ outside the set-point value. The PGOOD terminal should be connected through a pull-up resistor (suggested value $\pm 10\%$ to a source of 5 VDC or lower.



26. TUNABLE LOOP™

The SLIN-06E2A modules have a new feature that optimizes transient response of the module called Tunable Loop™.

External capacitors are usually added to the output of the module for two reasons: to reduce output ripple and noise and to reduce output voltage deviations from the steady-state value in the presence of dynamic load current changes. Adding external capacitance however affects the voltage control loop of the module, typically causing the loop to slow down with sluggish response. Larger values of external capacitance could also cause the module to become unstable.

The Tunable LoopTM allows the user to externally adjust the voltage control loop to match the filter network connected to the output of the module. The Tunable LoopTM is implemented by connecting a series R-C between the SENSE and TRIM pins of the module, as shown in below. This R-C allows the user to externally adjust the voltage loop feedback compensation of the module.

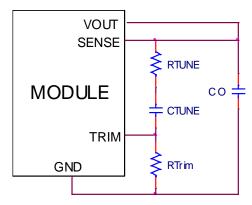


Figure 47. Circuit diagram showing connection of R_{TUME} and C_{TUNE} to tune the control loop of the module

Recommended values of R_{TUNE} and C_{TUNE} for different output capacitor combinations are given in below Tables 2 and 3. Table 2 shows the recommended values of R_{TUNE} and C_{TUNE} for different values of ceramic output capacitors up to 470 μ F that might be needed for an application to meet output ripple and noise requirements. Selecting R_{TUNE} and C_{TUNE} according to Table 2 will ensure stable operation of the module.

In applications with tight output voltage limits in the presence of dynamic current loading, additional output capacitance will be required. Table 3 lists recommended values of R_{TUNE} and C_{TUNE} in order to meet 2% output voltage deviation limits for some common output voltages in the presence of a 3 A to 6 A step change (50% of full load), with an input voltage of 12 V.

Со	1x 47 μF	2x 47 μF	4x 47 μF	6x 47 μF	10x 47 μF
RTUNE	270 Ω	220 Ω	150 Ω	75 Ω	75 Ω
CTUNE	2200 pF	4700 pF	8200 pF	12 nF	18 nF

Table 2. General recommended values of of RTUNE and CTUNE for Vin = 12 V and various external ceramic capacitor combinations.

Vo	5 V	3.3 V	2.5 V	1.8 V	1.2 V	0.6 V
Со	2x 47 μF	3x 47 μF	4x47μF	6x 47 μF	2x 47 μF+ 330 μF Polymer	3x 330 μF Polymer
RTUNE	220 Ω	180 Ω	150Ω	120 Ω	100 Ω	100 Ω
CTUNE	3900 pF	6800 pF	10 nF	12 nF	15 nF	120 nF
ΔV	87 mV	57 mV	43 mV	32 mV	23 mV	12 mV

Table 3. Recommended values of R_{TUNE} and C_{TUNE} to obtain transient deviation of $\leq 2\%$ of Vout for a 3 A step load with Vin = 12 V.



27. THERMAL CONSIDERATIONS

Power modules operate in a variety of thermal environments; however, sufficient cooling should always be provided to help ensure reliable operation.

Considerations include ambient temperature, airflow, module power dissipation, and the need for increased reliability. A reduction in the operating temperature of the module will result in an increase in reliability. The thermal data presented here is based on physical measurements taken in a wind tunnel.

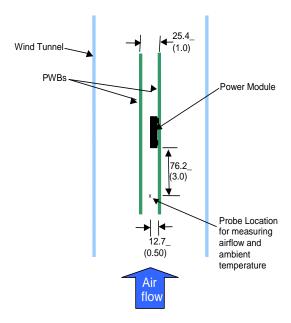


Figure 48. Thermal Test Setup

The thermal reference points, Tref used in the specifications are also shown in below. For reliable operation the temperatures at these points should not exceed 120°C. The output power of the module should not exceed the rated power of the module (Vo,set x lo,max).

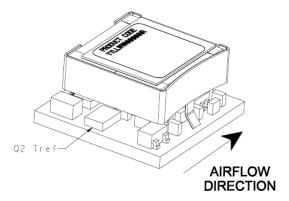


Figure 49. Preferred airflow direction and location of hot spot of the module (Tref).



28. EXAMPLE APPLICATION CIRCUIT

Requirements:

Vin: 12 V Vout: 1.8 V

lout: 4.5 A max., worst case load transient is from 3 A to 4.5 A Δ Vout: 1.5% of Vout (27 mV) for worst case load transient

Vin, ripple 1.5% of Vin (50 mV, p-p)

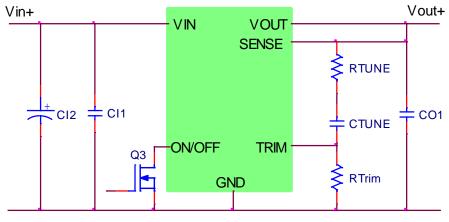


Figure 50.

CI1 22 µF/16 V ceramic capacitor (e.g. Murata GRM32ER61C226KE20)

CI2 47 µF/16 V bulk electrolytic

CO1 5 x 47 μF/6.3 V ceramic capacitor (e.g. Murata GRM31CR60J476ME19)

Ctune 12 nF ceramic capacitor (can be 1206, 0805 or 0603 size) Rtune 120 Ω SMT resistor (can be 1206, 0805 or 0603 size)

Rtrim 4.87 k Ω SMT resistor (can be 1206, 0805 or 0603 size, recommended tolerance of 0.1%)



29. MECHANICAL DIMENSIONS

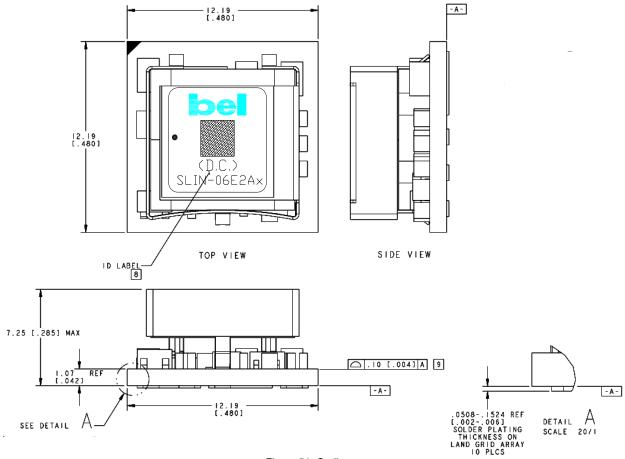


Figure 51. Outline

PIN CONNECTIONS

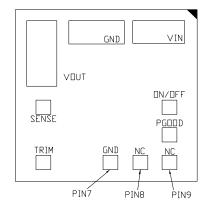


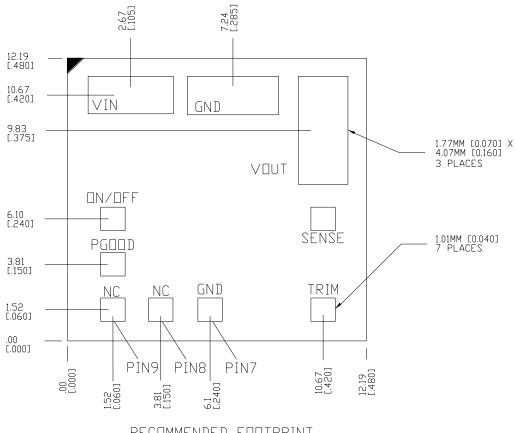
Figure 52. Pins





Asia-Pacific +86 755 298 85888 Europe, Middle East +353 61 49 8941 North America +1 866 513 2839

RECOMMENDED PAD LAYOUT



RECOMMENDED FOOTPRINT -THROUGH THE BOARD-

Figure 53.

Dimensions are in millimeter [inch].

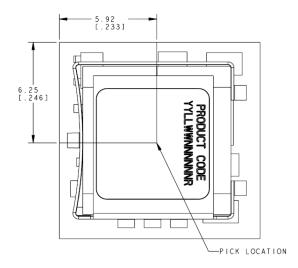
Tolerances: x.x mm \pm 0.5 mm [0.02 inch] [unless otherwise indicated] x.xx mm \pm 0.25 mm [0.010 inch]

Note: This module is recommended and compatible with Pb-Free Reflow Soldering and must be soldered using a reflow profile with a peak temperature of no more than 260 °C for less than 5 seconds.



30. PACKAGING DETAILS

The SLIN-06E2A modules are supplied in tape & reel as standard. All Dimensions are in millimeters and (in inches).



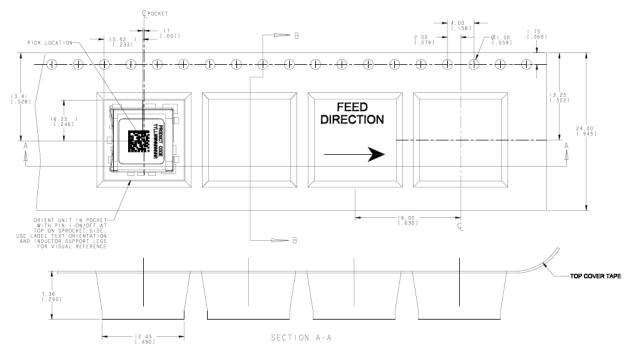


Figure 54.

Reel Dimensions:

Outside Dimensions: 330.2 mm [13.00 inch]
Inside Dimensions: 177.8 mm [7.00 inch)
Tape Width: 24.00 mm [0.945 inch]



31. SURFACE MOUNT INFORMATION PICK AND PLACE

The SLIN-06E2A modules use an open frame construction and are designed for a fully automated assembly process. The modules are fitted with a label designed to provide a large surface area for pick and place operations. The label meets all the requirements for surface mount processing, as well as safety standards, and can withstand reflow temperatures of up to 300°C. The label also carries product information such as part number and serial number.

NOZZLE RECOMMENDATIONS

The module weight has been kept to a minimum by using open frame construction. Variables such as nozzle size, tip style, vacuum pressure and placement speed should be considered to optimize this process. The minimum recommended inside nozzle diameter for reliable operation is 3mm. The maximum nozzle outer diameter, which will safely fit within the allowable component spacing, is 7 mm.

LEAD FREE SOLDERING

The SLIN-06E2A modules are lead-free (Pb-free) and RoHS compliant and fully compatible in a Pb-free soldering process. Failure to observe the instructions below may result in the failure of or cause damage to the modules and can adversely affect long-term reliability.

PB-FREE REFLOW PROFILE

Power Systems will comply with J-STD-020 Rev. C (Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices) for both Pb-free solder profiles and MSL classification procedures. This standard provides a recommended forced-air-convection reflow profile based on the volume and thickness of the package. The suggested Pb-free solder paste is Sn/Ag/Cu (SAC). The recommended linear reflow profile using Sn/Ag/Cu solder is shown in the figure below. Soldering outside of the recommended profile requires testing to verify results and performance.

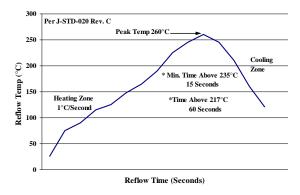


Figure 55. Recommended linear reflow profile using Sn/Ag/Cu solder.

MSL RATING

The SLIN-06E2A modules have a MSL rating of 2 A.

STORAGE AND HANDLING

The recommended storage environment and handling procedures for moisture-sensitive surface mount packages is detailed in J-STD-033 Rev. A (Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices). Moisture barrier bags (MBB) with desiccant are required for MSL ratings of 2 or greater. These sealed packages should not be broken until time of use. Once the original package is broken, the floor life of the product at conditions of $\leq 30^{\circ}$ C and 60% relative humidity varies according to the MSL



rating (see J-STD-033A). The shelf life for dry packed SMT packages will be a minimum of 12 months from the bag seal date, when stored at the following conditions: $< 40^{\circ}$ C, < 90% relative humidity.

32. REVISION HISTORY

DATE	REVISION	CHANGES DETAIL	APPROVAL
2009-6-1	Α	First release	T.Bubriski
2009-6-25	В	Section" Surface Mount Information" added.	T.Bubriski
2009-9-1	С	Tunable LoopTM logo added.	T.Bubriski
2009-10-8	D	Updated Startup Time waveforms on page 10.	T.Bubriski
2010-1-19	E	Updated Remote ON/OFF table on page 14.	T.Bubriski
2010-12-3	F	Updated the UVLO Turn-Off Thresholds page2, Thermal Derating Curves on page 6, and Remote ON/OFF table on page 14.	T.Bubriski
2012-6-26	G	Add label.	HL.Lu
2013-01-25	Н	Update UL.	HL.Lu
2014-5-20	1	Update MSL rating.	XF.Jiang
2016-10-27	AJ	Update input specifications, output specifications and output trim equations and example application circuit.	XF.Jiang
2021-08-17	AK	Add object ID and module photo. Update to new format. Update safety certificate.	XF.Jiang

For more information on these products consult: tech.support@psbel.com

NUCLEAR AND MEDICAL APPLICATIONS - Products are not designed or intended for use as critical components in life support systems, equipment used in hazardous environments, or nuclear control systems.

TECHNICAL REVISIONS - The appearance of products, including safety agency certifications pictured on labels, may change depending on the date manufactured. Specifications are subject to change without notice.

